RGS00TS65EHR

650V 50A Field Stop Trench IGBT

Datasheet

V _{CES}	650V
I _{C (100°C)}	50A
V _{CE(sat) (Typ.)}	1.65V
P_{D}	326W

Outline



Features

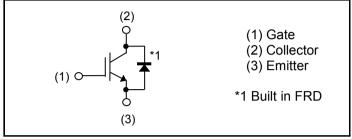
- 1) Low Collector Emitter Saturation Voltage
- 2) Short Circuit Withstand Time 8µs
- 3) Qualified to AEC-Q101
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating; RoHS Compliant

Application

General Inverter

for Automotive and Industrial Use

●Inner Circuit



Packaging Specifications

-	Packaging	Tube
	Reel Size (mm)	-
Typo	Tape Width (mm)	-
Type	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGS00TS65E

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Callagton Commant	T _C = 25°C	I _C	88	Α
Collector Current	T _C = 100°C	I _C	50	Α
Pulsed Collector Current	Pulsed Collector Current		150	Α
Diode Forward Current	T _C = 25°C	I _F	84	Α
	T _C = 100°C	I _F	50	Α
Diode Pulsed Forward Current		I _{FP} *1	150	Α
Power Dissipation	T _C = 25°C	P _D	326	W
	T _C = 100°C	P _D	163	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by T_{imax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
Falametei		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.46	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	0.80	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
- arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
		$V_{CE} = 650V, V_{GE} = 0V,$				
Collector Cut - off Current	I _{CES}	$Tj = 25^{\circ}C$ $T_j = 175^{\circ}C^{*2}$	-	-	10	μΑ
		$T_j = 175^{\circ}C^{*2}$	-	1	5	mA
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	ı	ı	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 2.5mA$	5.0	6.0	7.0	V
		$I_C = 50A, V_{GE} = 15V,$				
Collector - Emitter Saturation Voltage	V _{CE(sat)}	T _j = 25°C	-	1.65	2.10	V
		T _j = 175°C	-	2.15	-	

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Curaha al	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V,	-	1568	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$,	-	134	-	pF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	23	-	
Total Gate Charge	Q_g	V _{CE} = 300V,	-	58	-	
Gate - Emitter Charge	Q_ge	I _C = 50A,	-	15	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	24	-	
Turn - on Delay Time	t _{d(on)}		-	36	-	
Rise Time	t _r	$I_C = 50A, V_{CC} = 400V,$ $V_{GF} = 15V, R_G = 10\Omega,$	-	21	-	no
Turn - off Delay Time	$t_{d(off)}$	$T_i = 25^{\circ}C$	-	115	-	ns
Fall Time	t _f	Inductive Load	-	91	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	1.46	1	mJ
Turn - off Switching Loss	E _{off}	,	-	1.29	ı	
Turn - on Delay Time	t _{d(on)}		-	37	ı	ns
Rise Time	t _r	$I_{\rm C}$ = 50A, $V_{\rm CC}$ = 400V, $V_{\rm GE}$ = 15V, $R_{\rm G}$ = 10 Ω ,	-	33	ı	
Turn - off Delay Time	t _{d(off)}	$T_i = 175^{\circ}C$	-	145	-	
Fall Time	t _f	Inductive Load	-	154	1	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	2.00	-	mJ
Turn - off Switching Loss	E _{off}	,	-	1.87	-	1113
Reverse Bias	DDCOA	$I_C = 150A, V_{CC} = 520V,$	FULL SQUARE			-
Safe Operating Area	RBSUA	$V_P = 650V, V_{GE} = 15V,$ $R_G = 50\Omega, T_j = 175^{\circ}C$				
		V _{CC} ≤ 360V,				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V, T _j = 25°C	8	-	-	μs
Short Circuit Withstand Time	t _{sc} *2	$V_{CC} \le 360V$, $V_{GE} = 15V$, $T_i = 150^{\circ}C$	6	-	-	μs

^{*2} Design assurance without measurement

●FRD Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Cymphol	Conditions	Values			l lmit
	Symbol		Min.	Тур.	Max.	Unit
		I _F = 50A,				
Diode Forward Voltage	V_{F}	T _j = 25°C	-	1.45	1.90	V
		T _j = 175°C	-	1.50	ı	
Diode Reverse Recovery Time	t _{rr}	$I_F = 50A$, $V_{CC} = 400V$, $di_F/dt = 200A/\mu s$, $T_j = 25^{\circ}C$	-	113	-	ns
Diode Peak Reverse Recovery Current	Im		-	14.1	-	Α
Diode Reverse Recovery Charge	Q _{rr}		-	0.92	-	μC
Diode Reverse Recovery Energy	E _{rr}		-	275	-	μJ
Diode Reverse Recovery Time	t _{rr}	$I_F = 50A,$ $V_{CC} = 400V,$ $di_F/dt = 200A/\mu s,$ $T_j = 175^{\circ}C$	-	256	-	ns
Diode Peak Reverse Recovery Current	Im		-	18.6	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	2.54	-	μC
Diode Reverse Recovery Energy	E _{rr}		-	565	-	μJ

• Electrical Characteristic Curves

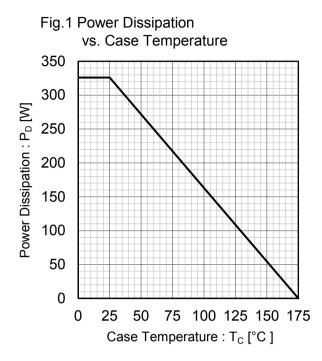


Fig.2 Collector Current vs. Case Temperature 100 90 80 Collector Current : Ic [A] 70 60 50 40 30 20 $T_i \le 175^{\circ}C_i$ 10 , GE ≥ 15V 25 50 75 100 125 150 175 Case Temperature : T_C [°C]

Fig.3 Forward Bias Safe Operating Area

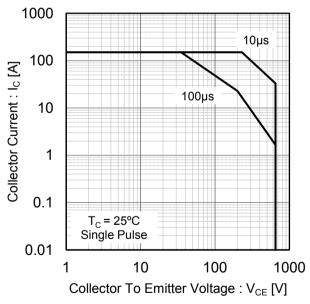
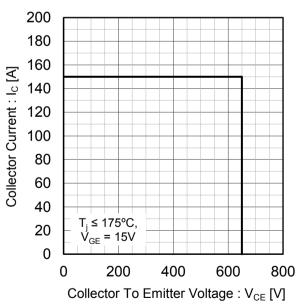


Fig.4 Reverse Bias Safe Operating Area



• Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

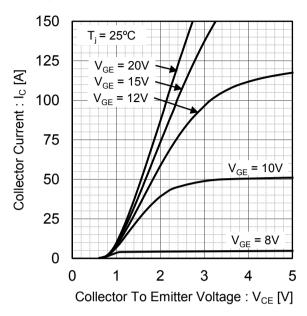


Fig.6 Typical Output Characteristics

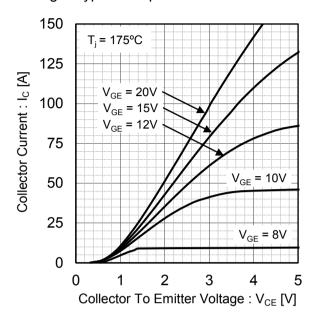


Fig.7 Typical Transfer Characteristics

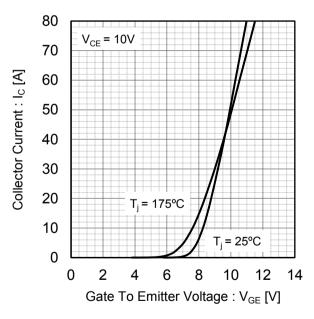
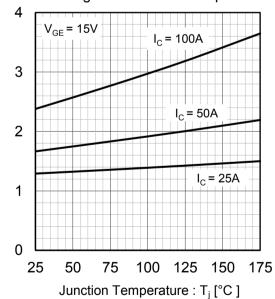


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

● Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

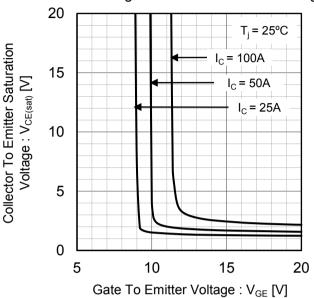


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

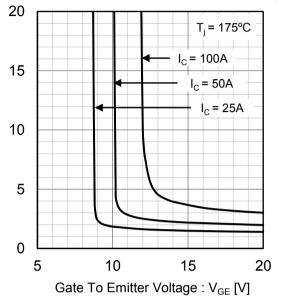


Fig.11 Typical Switching Time vs. Collector Current

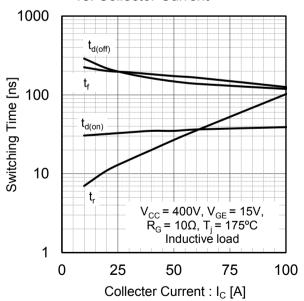
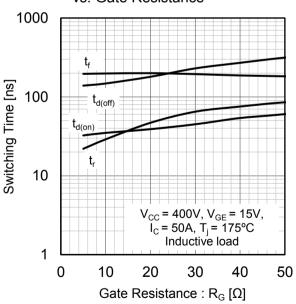


Fig.12 Typical Switching Time vs. Gate Resistance



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

0

25

• Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current

10

E_{off}

V_{CC} = 400V, V_{GE} = 15V, R_G = 10Ω, T_j = 175°C Inductive load

0.01

50

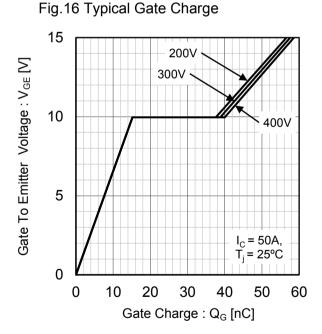
Collecter Current : I_C [A]

75

100

Fig.14 Typical Switching Energy Losses vs. Gate Resistance 10 E_{on} Switching Energy Losses [mJ] E_{off} 1 0.1 V_{CC} = 400V, I_{C} = 50A, V_{GE} = 15V, T_{j} = 175°C Inductive load 0.01 0 10 20 30 40 50 Gate Resistance : $R_G[\Omega]$

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 C_{ies} 1000 Capacitance [pF] $\mathsf{C}_{\mathsf{oes}}$ 100 C_{res} 10 f = 1MHz. $V_{GE} = 0V$ = 25°C 1 0.01 0.1 10 100 Collector To Emitter Voltage: V_{CE} [V]



Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage

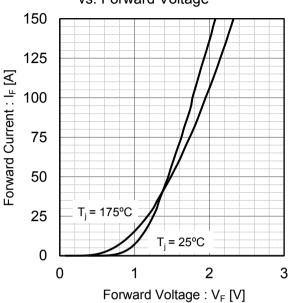


Fig.18 Typical Diode Revese Recovery Time vs. Forward Current

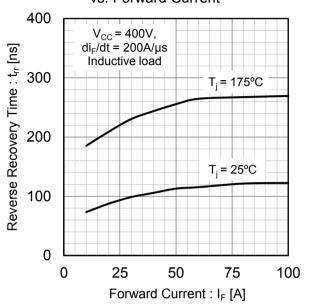


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

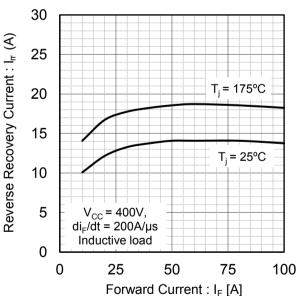
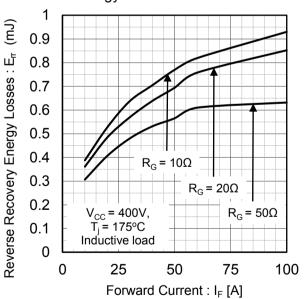


Fig.20 Typical Diode Rrverse Recovery Energy Losses vs. Forward Current



• Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

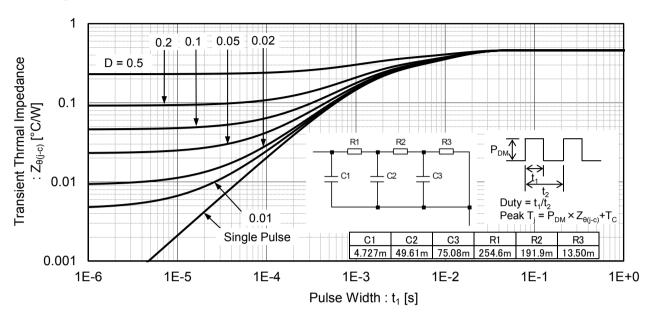
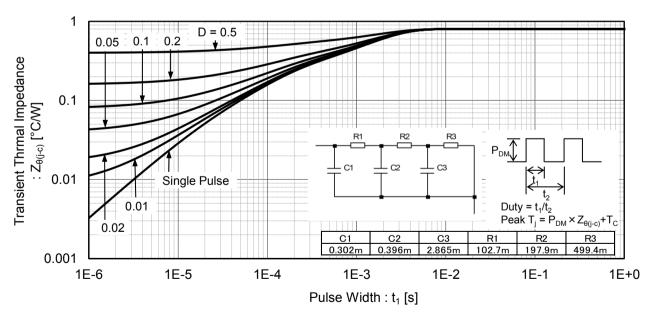


Fig.22 Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

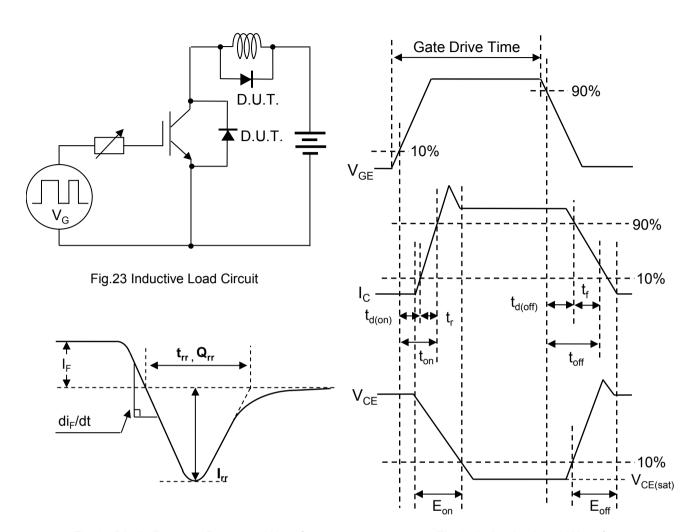


Fig.25 Diode Reverse Recovery Waveform

Fig.24 Inductive Load Waveform

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